

### **Technical Data Sheet**

#### MODEL NO: P190ROM4

0603 Package 1.6 \*0.8\*0.8mm Ambient light Sensor

#### Features:

- Adapted to human eye responsively
- Ambient light sensor is a silicon NPN epitaxial planar phototransistor
- ●It is sensitive to visible light much like the human eye and has peak sensitivity at 590nm
- Compatible with automatic placement equipment
- Compatible with reflow solder process
- Package in 8mm tape on 7" diameter reels.

#### Applications:

- Automotive sensors
- Mobile phones
- •Cameras, Dashboards

Dice material	Resin	Lens Color		
Silicon	Epoxy	Water clear lens		

### Electrical/Optical Characteristics(Ta=25℃)

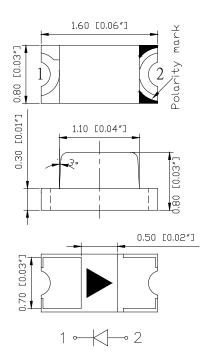
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	I <sub>C</sub> = 0.1 mA	V <sub>CEO</sub>	6			٧
Collector dark current	V <sub>CE</sub> = 5 V, E = 0 lx	I <sub>CEO</sub>		3	50	nA
Collector emitter capacitance	V <sub>CE</sub> = 0 V, f = 1 MHz, E = 0 lx	C <sub>CEO</sub>		16		pF
Photo current	E <sub>V</sub> = 20 lx, CIE illuminant A, V <sub>CE</sub> = 5 V	IPCE		4.6		μΑ
	E <sub>V</sub> = 100 lx, CIE illuminant A, V <sub>CE</sub> = 5 V	I <sub>PCE</sub>	7.5	23	39	μΑ
Temperature coefficient of I <sub>PCE</sub>	CIE illuminant A	TK <sub>IPCE</sub>		1.18		%/K
	LED, white	TK <sub>IPCE</sub>		0.9		%/K
Angle of half sensitivity		φ		± 60		deg
Wavelength of peak sensitivity		λρ		590		nm
Range of spectral bandwidth		λ <sub>0.5</sub>		450 to 610		nm
Collector emitter saturation voltage	E <sub>V</sub> = 20 lx, 0.45 μA	V <sub>CEsat</sub>		0.1		٧



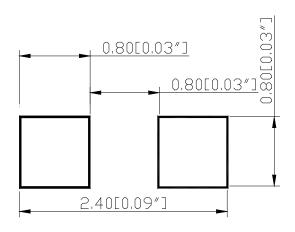
Absolute Maximum Ratings(Ta= $25^{\circ}$ C)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Collector emitter voltage		V <sub>CEO</sub>	6	٧
Emitter collector voltage		V <sub>ECO</sub>	1.5	٧
Collector current		Ic	20	mA
Power dissipation		P <sub>V</sub>	100	mW
Junction temperature		Tj	100	°C
Operating temperature range		T <sub>amb</sub>	-40 to +100	°C
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C
Soldering temperature	Acc. reflow profile fig. 9	T <sub>sd</sub>	260	°C
Thermal resistance junction/ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	R <sub>thJA</sub>	450	K/W

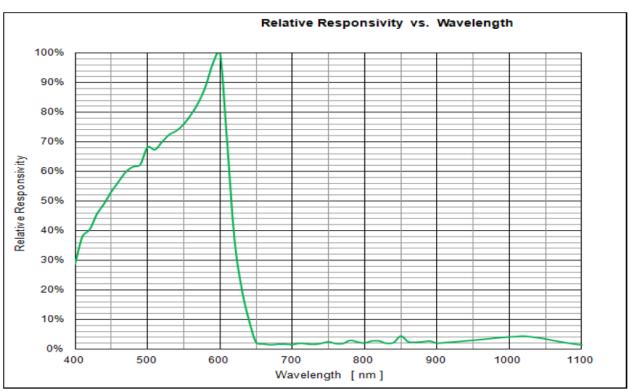
## PACKAGING DIMENSIONS



## RECOMMEND PAD LAYOUT



# Relative spectral response vs. wavelength:

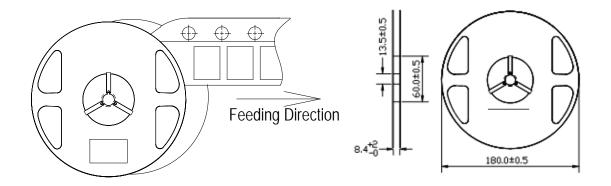


<sup>\*</sup> measured by bare chip, for reference only.

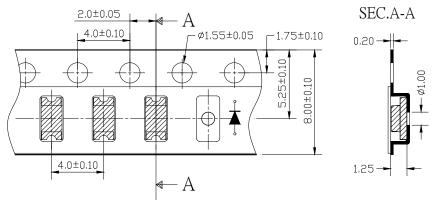


## Feeding Direction

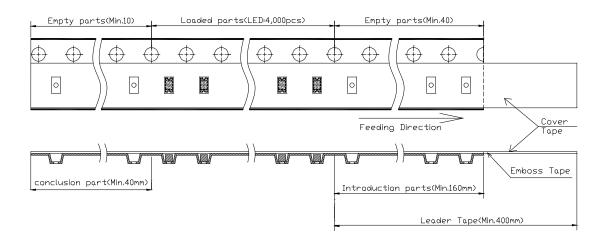
## • Dimensions of Reel (Unit: mm)



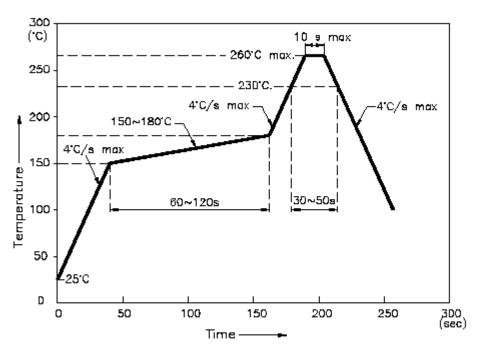
## • Dimensions of Tape (Unit: mm)



## Arrangement of Tape



Reflow Soldering Profile For Lead-free SMT Process.



#### NOTES:

- 1.We recommend the reflow temperature  $245^{\circ}C(+/-5^{\circ}C)$ .The maximum soldering temperature should be limited to  $260^{\circ}C$ .
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.